PESDxL5UF; PESDxL5UV; PESDxL5UY

Low capacitance unidirectional fivefold ESD protection diode arrays

Rev. 02 — 8 January 2008

Product data sheet

1. Product profile

1.1 General description

Low capacitance unidirectional fivefold ElectroStatic Discharge (ESD) protection diode arrays in small Surface-Mounted Device (SMD) plastic packages designed to protect up to five unidirectional signal lines from the damage caused by ESD and other transients.

Table 1. Product overview

Type number	Package		Package configuration	
	Nexperia	JEITA	JEDEC	
PESD3V3L5UF	SOT886	-	MO-252	leadless ultra small
PESD5V0L5UF	SOT886	-	MO-252	leadless ultra small
PESD3V3L5UV	SOT666	-	-	ultra small and flat lead
PESD5V0L5UV	SOT666	-	-	ultra small and flat lead
PESD3V3L5UY	SOT363	SC-88	-	very small
PESD5V0L5UY	SOT363	SC-88	-	very small

1.2 Features

- ESD protection of up to five lines
- Low diode capacitance
- Max. peak pulse power: P_{PP} = 25 W
- Low clamping voltage: V_{CL} = 12 V
- Ultra low leakage current: I_{RM} = 5 nA
- ESD protection up to 20 kV
- IEC 61000-4-2; level 4 (ESD)
- IEC 61000-4-5 (surge); I_{PP} = 2.5 A

1.3 Applications

- Computers and peripherals
- Audio and video equipment
- Cellular handsets and accessories
- Communication systems
- Portable electronics
- Subscriber Identity Module (SIM) card protection



1.4 Quick reference data

Table 2. Quick reference data

 $T_{amb} = 25 \,^{\circ}C$ unless otherwise specified.

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode						
V_{RWM}	reverse standoff voltage					
	PESD3V3L5UF PESD3V3L5UV PESD3V3L5UY		-	-	3.3	V
	PESD5V0L5UF PESD5V0L5UV PESD5V0L5UY		-	-	5.0	V
C_d	diode capacitance	$f = 1 MHz; V_R = 0 V$				
- u	PESD3V3L5UF PESD3V3L5UV PESD3V3L5UY		-	22	28	pF
	PESD5V0L5UF PESD5V0L5UV PESD5V0L5UY		-	16	19	pF

2. Pinning information

Table 3. Pinning

Table 3.	Filling		
Pin	Description	Simplified outline	Symbol
PESD3V	3L5UF; PESD5V0L5UF		
1	cathode (diode 1)		
2	common anode	1 2 3	1 6
3	cathode (diode 2)		2 5
4	cathode (diode 3)		3 4
5	cathode (diode 4)	6 5 4	006aaa159
6	cathode (diode 5)	6 5 4 bottom view	
PESD3V	3L5UV; PESD5V0L5UV		
1	cathode (diode 1)		
2	common anode	6 5 4	1 6
3	cathode (diode 2)		2 5
4	cathode (diode 3)		3 4
5	cathode (diode 4)	1 2 3	006aaa159
6	cathode (diode 5)	1 2 3	

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Table 3. Pinning ...continued

Pin	Description	Simplified outline	Symbol
PESD3V	3L5UY; PESD5V0L5UY		
1	cathode (diode 1)		
2	common anode	6 5 4	1 [] • [] 6
3	cathode (diode 2)		2 5
4	cathode (diode 3)	0	3 4
5	cathode (diode 4)	□1 □2 □3	006aaa159
6	cathode (diode 5)		

Ordering information 3.

Table 4. **Ordering information**

Type number	Package					
	Name	Description	Version			
PESD3V3L5UF	XSON6	plastic extremely thin small outline package;	SOT886			
PESD5V0L5UF		no leads; 6 terminals; body $1 \times 1.45 \times 0.5$ mm				
PESD3V3L5UV	-	plastic surface-mounted package; 6 leads	SOT666			
PESD5V0L5UV						
PESD3V3L5UY	SC-88	plastic surface-mounted package; 6 leads	SOT363			
PESD5V0L5UY						

Marking 4.

Table 5. **Marking codes**

Type number	Marking code[1]
PESD3V3L5UF	A1
PESD5V0L5UF	A2
PESD3V3L5UV	E1
PESD5V0L5UV	E2
PESD3V3L5UY	K3*
PESD5V0L5UY	K4*

[1] * = -: made in Hong Kong

* = p: made in Hong Kong

* = t: made in Malaysia

* = W: made in China

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5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per diode					
P_{PP}	peak pulse power	$t_p = 8/20 \ \mu s$	[1][2]	25	W
I _{PP}	peak pulse current	$t_p = 8/20 \ \mu s$	[1][2]	2.5	Α
Per device					
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

^[1] Non-repetitive current pulse 8/20 µs exponential decay waveform according to IEC 61000-4-5.

Table 7. ESD maximum ratings

 $T_{amb} = 25 \,^{\circ}C$ unless otherwise specified.

u	•					
Symbol	Parameter	Conditions		Min	Max	Unit
Per diode						
V_{ESD}	electrostatic discharge voltage	IEC 61000-4-2 (contact discharge)	[1][2]	-	20	kV
		MIL-STD-883 (human body model)		-	10	kV

^[1] Device stressed with ten non-repetitive ESD pulses.

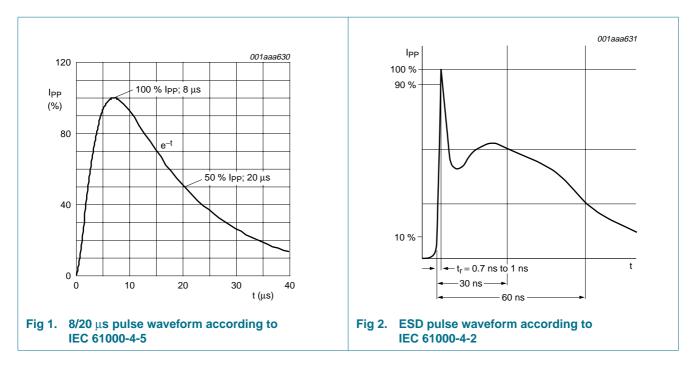
Table 8. ESD standards compliance

Standard	Conditions
Per diode	
IEC 61000-4-2; level 4 (ESD)	> 15 kV (air); > 8 kV (contact)
MIL-STD-883; class 3 (human body model)	> 4 kV

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^[2] Measured from pin 1, 3, 4, 5 or 6 to pin 2.

^[2] Measured from pin 1, 3, 4, 5 or 6 to pin 2.



6. Characteristics

Table 9. Characteristics

T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diod	е					
V_{RWM}	reverse standoff voltage					
I _{RM}	PESD3V3L5UF PESD3V3L5UV PESD3V3L5UY		-	-	3.3	V
	PESD5V0L5UF PESD5V0L5UV PESD5V0L5UY		-	-	5.0	V
I _{RM}	reverse leakage current					
	PESD3V3L5UF PESD3V3L5UV PESD3V3L5UY	$V_{RWM} = 3.3 V$	-	75	300	nA
	PESD5V0L5UF PESD5V0L5UV PESD5V0L5UY	V _{RWM} = 5.0 V	-	5	25	nA
V_{BR}	breakdown voltage	I _R = 1 mA				
v BR	PESD3V3L5UF PESD3V3L5UV PESD3V3L5UY		5.3	5.6	5.9	V
	PESD5V0L5UF PESD5V0L5UV PESD5V0L5UY		6.4	6.8	7.2	V

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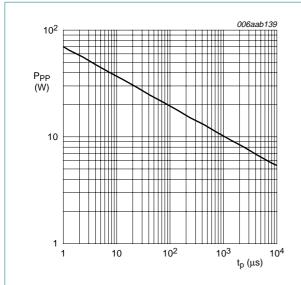
Table 9. Characteristics ... continued

 T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C _d	diode capacitance	f = 1 MHz; $V_R = 0 V$				
	PESD3V3L5UF PESD3V3L5UV PESD3V3L5UY		-	22	28	pF
	PESD5V0L5UF PESD5V0L5UV PESD5V0L5UY		-	16	19	pF
V _{CL}	clamping voltage		[1][2]			
	PESD3V3L5UF PESD3V3L5UV PESD3V3L5UY	I _{PP} = 1 A	-	-	10	V
	PESD3V3L5UF PESD3V3L5UV PESD3V3L5UY	I _{PP} = 2.5 A	-	-	12	V
	PESD5V0L5UF PESD5V0L5UV PESD5V0L5UY	I _{PP} = 1 A	-	-	10	V
	PESD5V0L5UF PESD5V0L5UV PESD5V0L5UY	I _{PP} = 2.5 A	-	-	12	V
r _{dif}	differential resistance	$I_R = 1 \text{ mA}$				
	PESD3V3L5UF PESD3V3L5UV PESD3V3L5UY		-	-	200	Ω
	PESD5V0L5UF PESD5V0L5UV PESD5V0L5UY		-	-	100	Ω

^[1] Non-repetitive current pulse $8/20~\mu s$ exponential decay waveform according to IEC 61000-4-5.

^[2] Measured from pin 1, 3, 4, 5 or 6 to pin 2.



 $T_{amb} = 25 \, ^{\circ}C$

Fig 3. Peak pulse power as a function of exponential pulse duration; typical values

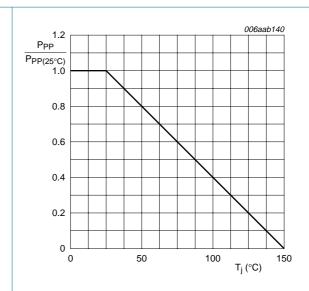
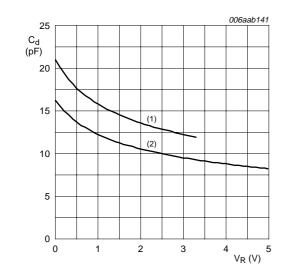


Fig 4. Relative variation of peak pulse power as a function of junction temperature; typical values



 $f = 1 \text{ MHz}; T_{amb} = 25 \,^{\circ}\text{C}$

- (1) PESD3V3L5UF; PESD3V3L5UV; PESD3V3L5UY
- (2) PESD5V0L5UF; PESD5V0L5UV; PESD5V0L5UY



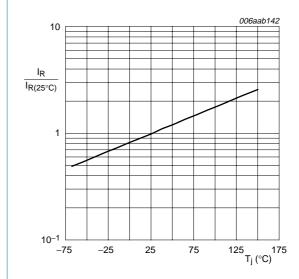
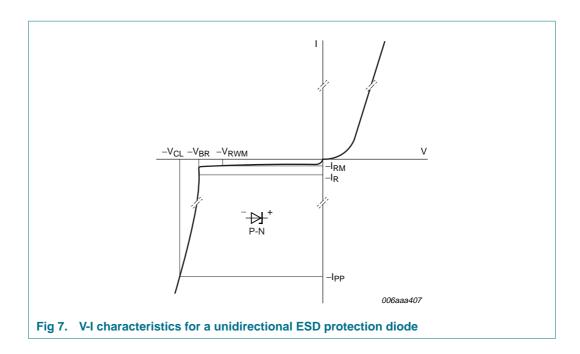


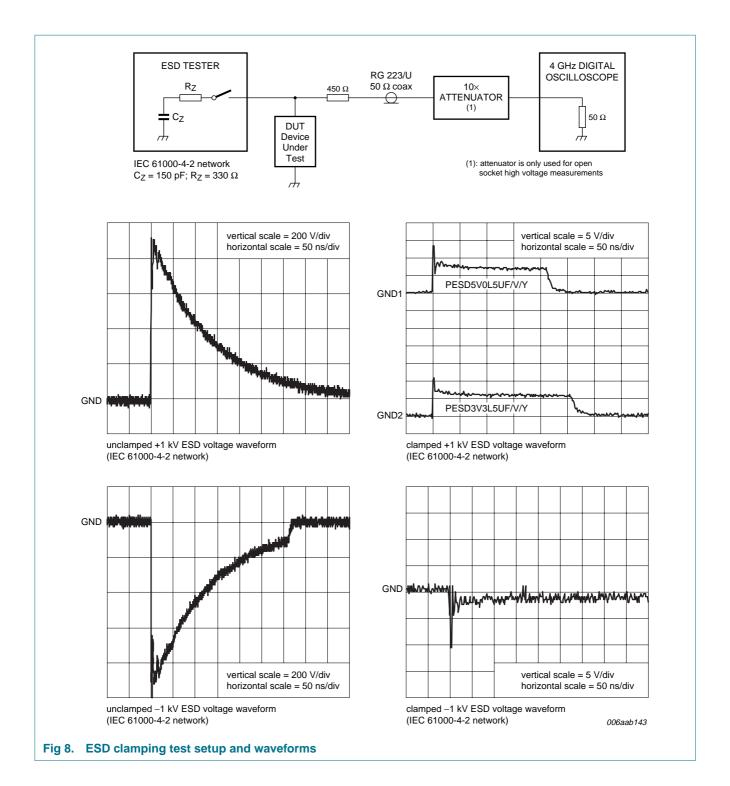
Fig 6. Relative variation of reverse current as a function of junction temperature; typical values

Product data sheet



Product data sheet

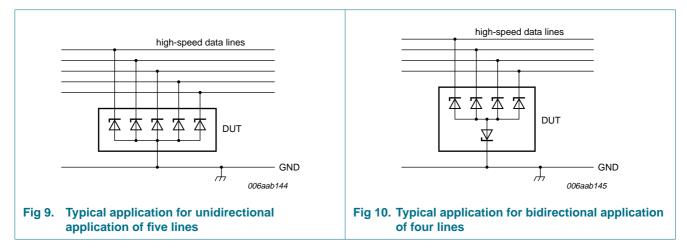
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Application information 7.

The devices are designed for the protection of up to five unidirectional data or signal lines from the damage caused by ESD and surge pulses. The devices may be used on lines where the signal polarities are both, positive and negative with respect to ground. The devices provide a surge capability of 25 W per line for an 8/20 µs waveform each.



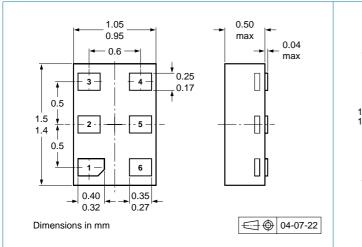
Circuit board layout and protection device placement

Circuit board layout is critical for the suppression of ESD, Electrical Fast Transient (EFT) and surge transients. The following guidelines are recommended:

- 1. Place the device as close to the input terminal or connector as possible.
- 2. The path length between the device and the protected line should be minimized.
- 3. Keep parallel signal paths to a minimum.
- 4. Avoid running protected conductors in parallel with unprotected conductors.
- 5. Minimize all Printed-Circuit Board (PCB) conductive loops including power and ground loops.
- 6. Minimize the length of the transient return path to ground.
- 7. Avoid using shared transient return paths to a common ground point.
- 8. Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

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Package outline



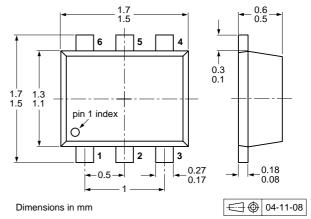


Fig 11. Package outline PESDxL5UF (SOT886)

Fig 12. Package outline PESDxL5UV (SOT666)

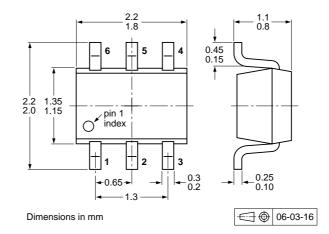


Fig 13. Package outline PESDxL5UY (SOT363/SC-88)

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Packing information

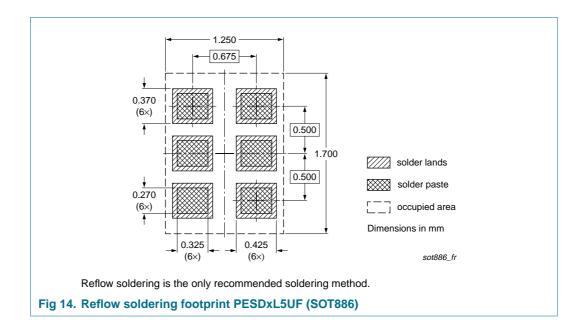
Table 10. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description		Packing quantity					
				3000	4000	5000	8000	10000	
PESD3V3L5UF	SOT886	4 mm pitch, 8 mm tape and reel; T1	<u>[2]</u>	-	-	-115	-	-	
		4 mm pitch, 8 mm tape and reel; T4	<u>[3]</u>	-	-	-132	-	-	
PESD5V0L5UF	SOT886	4 mm pitch, 8 mm tape and reel; T1	[2]	-	-	-115	-	-	
		4 mm pitch, 8 mm tape and reel; T4	<u>[3]</u>	-	-	-132	-	-	
PESD3V3L5UV SOT66	SOT666	2 mm pitch, 8 mm tape and reel		-	-	-	-315	-	
		4 mm pitch, 8 mm tape and reel		-	-115	-	-	-	
PESD5V0L5UV	SOT666	2 mm pitch, 8 mm tape and reel		-	-	-	-315	-	
		4 mm pitch, 8 mm tape and reel		-	-115	-	-	-	
PESD3V3L5UY	SOT363	4 mm pitch, 8 mm tape and reel; T1	[2]	-115	-	-	-	-135	
		4 mm pitch, 8 mm tape and reel; T2	<u>[4]</u>	-125	-	-	-	-165	
PESD5V0L5UY	SOT363	4 mm pitch, 8 mm tape and reel; T1	[2]	-115	-	-	-	-135	
		4 mm pitch, 8 mm tape and reel; T2	<u>[4]</u>	-125	-	-	-	-165	

^[1] For further information and the availability of packing methods, see Section 13.

10. Soldering

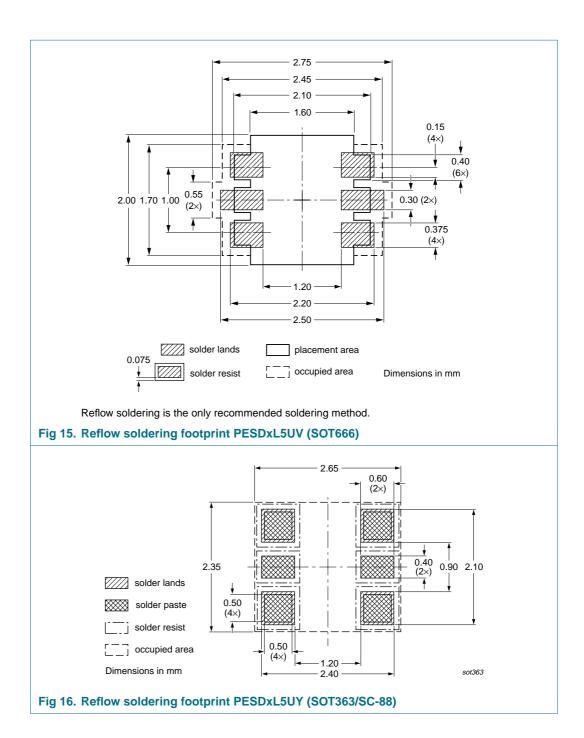


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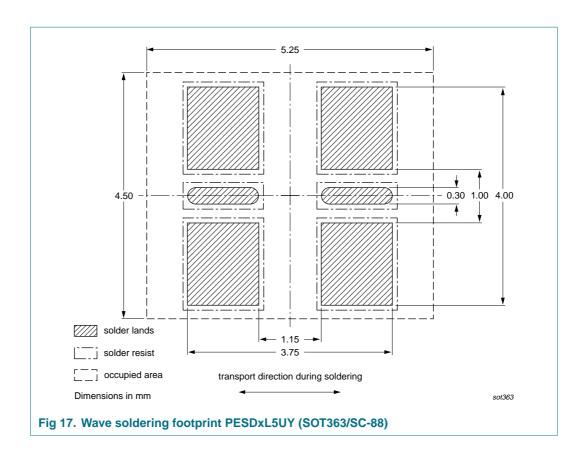
T1: normal taping

T4: 90° rotated reverse taping

T2: reverse taping



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11. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
PESDXL5UF_V_Y_2	20080108	Product data sheet	-	PESD3V3L5UV_ PESD5V0L5UV_1 PESD3V3L5UY_ PESD5V0L5UY_1	
Modifications:		he format of this data sheet has been redesigned to comply with the new lentity guidelines of NXP Semiconductors.			
	 Legal texts have been adapted to the new company name where appropriate. 				
	 Type numbers PESD3V3L5UF and PESD5V0L5UF added 				
	<u>Table 1 "Product overview"</u> : added				
	 Section 4 "Marking": marking code for PESD3V3L5UV amended 				
	 Section 4 "Marking": marking code for PESD5V0L5UV amended 				
	 Section 4 "Marking": marking code for PESD3V3L5UY amended 				
	 Section 4 "Marking": marking code for PESD5V0L5UY amended 				
	• Figure 7: added				
	Section 9 "Packing information": added				
	Section 10 "Soldering": added				
	Section 12	! "Legal information": up	odated		
PESD3V3L5UV_PESD5V0L5UV_1	20040323	Product specification	-	-	
PESD3V3L5UY_PESD5V0L5UY_1	20040323	Product specification	-	-	

12. Legal information

12.1 **Data sheet status**

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
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